SUM110P06-07L



Vishay Siliconix

P-Channel 60 V (D-S) 175 °C MOSFET

FEATURES

PRODUCT SUMMARY				
V _{DS} (V)	V _{DS} (V) R _{DS(on)} (Ω)			
-60	0.0069 at V _{GS} = -10 V	-110		
	0.0088 at V _{GS} = -4.5 V	-110		



Ordering Information:

SUM110P06-07L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted) PARAMETER SYMBOL UNIT LIMIT Drain-Source Voltage -60 V_{DS} ٧ Gate-Source Voltage ± 20 V_{GS} T_C = 25 °C -110 Continuous Drain Current ^d I_D $(T_{.1} = 175 \ ^{\circ}C)$ $T_C = 125 \circ C$ -95 А Pulsed Drain Current -240 I_{DM} Avalanche Current -75 I_{AS} L = 0.1 mHSingle Pulse Avalanche Energy ^a 281 mJ E_{AS} T_C = 25 °C ° 375 Power Dissipation W P_D $T_A = 25 \circ C^b$ 3.75 Operating Junction and Storage Temperature Range T_J, T_{stg} -55 to +175 °C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	UNIT	
Junction-to-Ambient	PCB mount ^b	R _{thJA}	40	°C/W	
Junction-to-Case		R _{thJC}	0.4	0/11	

Notes

- a. Duty cycle ≤ 1 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. See SOA curve for voltage derating.

d. Limited by package.

• TrenchFET[®] power MOSFET • Package with low thermal resistance

• Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



Vishay Siliconix

VISHAY	
	www.

.vishay.com

SUM110P06-07L

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-60	-	-	v
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA -1		-	-3	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	
	I _{DSS}	V_{DS} = -60 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	-50	μA
		V_{DS} = -60 V, V_{GS} = 0 V, T_{J} = 175 °C	-	-	-250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	-120	-	-	А
		V _{GS} = -10 V, I _D = -30 A	-	0.0055	0.0069	
Drain Source On State Resistance a	Б	V_{GS} = -10 V, I_D = -30 A, T_J = 125 °C	-	-	0.0115	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = -10 V, I_D = -30 A, T_J = 175 °C	-	-	0.0138	Ω
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	0.0070	0.0088	İ
Forward Transconductance a	9 _{fs}	V _{DS} = -15 V, I _D = -50 A	20	-	-	S
Dynamic ^b						
Input Capacitance	C _{iss}		-	11 400	-	pF
Output Capacitance	Coss	$V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz$	-	1200	-	
Reverse Transfer Capacitance	C _{rss}		-	900	-	
Total Gate Charge ^c	Qg		-	230	345	nC
Gate-Source Charge ^c	Q _{gs}	V_{DS} = -30 V, V_{GS} = -10 V, I_D = -110 A	-	50	-	
Gate-Drain Charge ^c	Q _{gd}		-	60	-	
Gate Resistance	Rg	f = 1 MHz	-	3	-	Ω
Turn-On Delay Time ^c	t _{d(on)}		-	20	30	
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, \text{ R}_{\text{L}} = 0.27 \Omega$	-	25	40	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -110$ A, $V_{GEN} = -10$ V, $R_g = 1$ Ω	-	110	200	
Fall Time ^c	t _f		-	50	100	
Drain-Source Body Diode Character	istics (T _C = 25	s °C b)				
Continuous Current	I _S		-	-	-110	A
Pulsed Current	I _{SM}		-	-	-240	А
Forward Voltage ^a	V _{SD}	I _F = -85 A, V _{GS} = 0 V	-	-1	-1.5	V
Reverse Recovery Time	t _{rr}		-	91	137	ns
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = -85 A, dl/dt = 100 A/μs	-	-6	-9	А
Reverse Recovery Charge	Q _{rr}		-	0.21	0.44	μC

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4 V

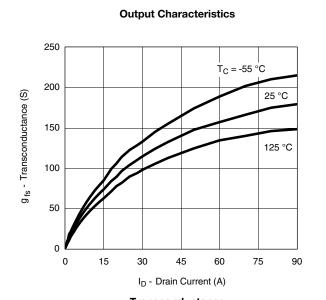
3 V

10

8

6 V_{DS} - Drain-to-Source Voltage (V)

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



4

www.vishay.com

V_{GS} = 10 V thru 5 V

ISHAY

200

160

120

80

40

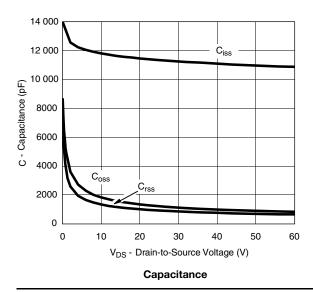
0

0

2

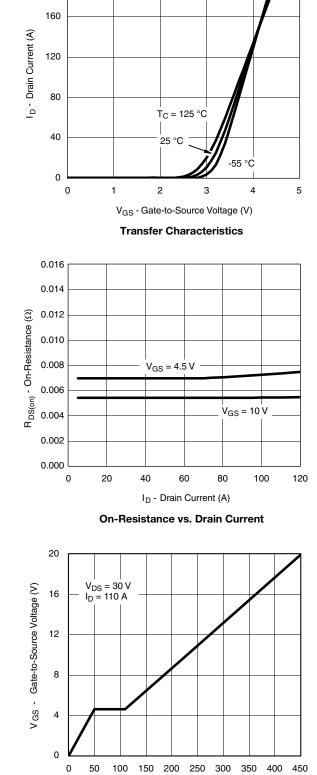
I_D - Drain Current (A)







200



S15-1278-Rev. D, 08-Jun-15

3

Document Number: 72439

Total Gate Charge (nC)

Gate Charge

Qq

For technical questions, contact: pmostechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

SUM110P06-07L

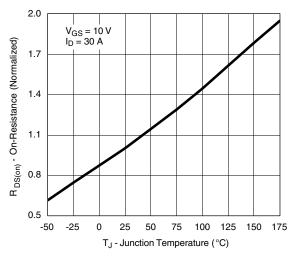
Vishay Siliconix

Vishay Siliconix

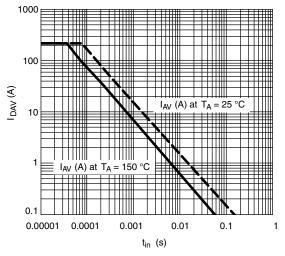
SUM110P06-07L

VISHAY, www.vishay.com

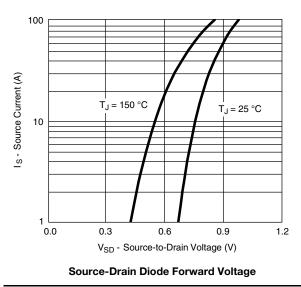
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

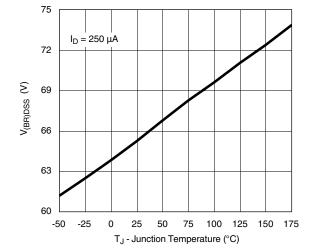


On-Resistance vs. Junction Temperature

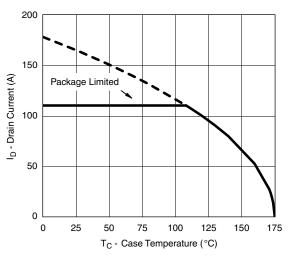




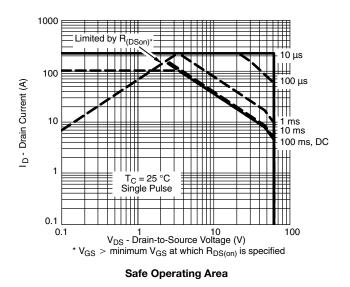




Drain Source Breakdown vs. Junction Temperature



Maximum Avalanche and Drain Current vs. Case Temperature



S15-1278-Rev. D, 08-Jun-15

4

Document Number: 72439

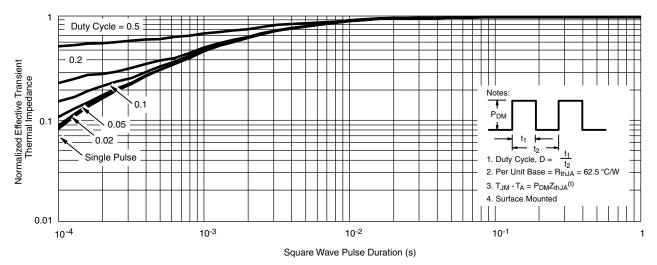
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

SUM110P06-07L



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72439.



Vishay Siliconix

TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INC	HES	MILLIMETERS			
DIM.		MIN.	MAX.	MIN.	MAX.		
A		0.160	0.190	4.064	4.826		
	b	0.020	0.039	0.508	0.990		
	b1	0.020	0.035	0.508	0.889		
b2		0.045	0.055	1.143	1.397		
с*	Thin lead	0.013	0.018	0.330	0.457		
	Thick lead	0.023	0.028	0.584	0.711		
<u>1</u>	Thin lead	0.013	0.017	0.330	0.431		
c1	Thick lead	0.023	0.027	0.584	0.685		
	c2	0.045	0.055	1.143	1.397		
	D	0.340	0.380	8.636	9.652		
D1		0.220	0.240	5.588	6.096		
D2		0.038	0.042	0.965	1.067		
D3		0.045	0.055	1.143	1.397		
D4		0.044	0.052	1.118	1.321		
	E	0.380	0.410	9.652	10.414		
	E1	0.245	-	6.223	-		
E2		0.355	0.375	9.017	9.525		
	E3	0.072	0.078	1.829	1.981		
	е	0.100	0.100 BSC 2.54 BSC		BSC		
	К	0.045	0.055	1.143	1.397		
	L	0.575	0.625	14.605	15.875		
	L1	0.090	0.110	2.286	2.794		
L2		0.040	0.055	1.016	1.397		
	L3	0.050	0.070	1.270	1.778		
	L4	0.010 BSC		0.254 BSC			
	M - 0.002 - 0		0.050				
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843							

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B